



High power cycling capability  
Low on-state and switching losses  
Designed for traction and industrial applications

## Phase Control Thyristor Type T553-500-44

|                                   |           |           |                       |      |
|-----------------------------------|-----------|-----------|-----------------------|------|
| Mean on-state current             |           | $I_{TAV}$ | 500 A                 |      |
| Repetitive peak off-state voltage |           | $V_{DRM}$ | 3800 ÷ 4400 V         |      |
| Repetitive peak reverse voltage   |           | $V_{RRM}$ |                       |      |
| Turn-off time                     |           | $t_q$     | 500, 630, 800 $\mu$ s |      |
| $V_{DRM}, V_{RRM}, V$             | 3800      | 4000      | 4200                  | 4400 |
| Voltage code                      | 38        | 40        | 42                    | 44   |
| $T_j, ^\circ C$                   | -60 ÷ 125 |           |                       |      |

### MAXIMUM ALLOWABLE RATINGS

| Symbols and parameters |  | Units             | Values   | Test conditions   |
|------------------------|--|-------------------|--|---|
| <b>ON-STATE</b>        |  |                   |  |   |
| $I_{TAV}$              | Mean on-state current  | A                 | 500<br>824                                     | $T_c=106^\circ C$ , Double side cooled<br>$T_c=85^\circ C$ , Double side cooled<br>180° half-sine wave; 50 Hz   |
| $I_{TRMS}$             | RMS on-state current   | A                 | 785  | $T_c=106^\circ C$ , Double side cooled<br>180° half-sine wave; 50 Hz  |
| $I_{TSM}$              | Surge on-state current   | kA                | 14.0<br>16.0                                   | $T_j=T_{j\ max}$<br>$T_j=25^\circ C$<br>180° half-sine wave;<br>$t_p=10\ ms$ ; single pulse;<br>$V_D=V_R=0\ V$ ;<br>Gate pulse: $I_G=2\ A$ ;<br>$t_{GP}=50\ \mu s$ ; $di_G/dt \geq 1\ A/\mu s$  |
|                        |  |                   | 15.0<br>17.0                                   | $T_j=T_{j\ max}$<br>$T_j=25^\circ C$<br>180° half-sine wave;<br>$t_p=8.3\ ms$ ; single pulse;<br>$V_D=V_R=0\ V$ ;<br>Gate pulse: $I_G=2\ A$ ;<br>$t_{GP}=50\ \mu s$ ; $di_G/dt \geq 1\ A/\mu s$ |
| $I^2t$                 | Safety factor  | $A^2s \cdot 10^3$ | 980<br>1280                                    | $T_j=T_{j\ max}$<br>$T_j=25^\circ C$<br>180° half-sine wave;<br>$t_p=10\ ms$ ; single pulse;<br>$V_D=V_R=0\ V$ ;<br>Gate pulse: $I_G=2\ A$ ;<br>$t_{GP}=50\ \mu s$ ; $di_G/dt \geq 1\ A/\mu s$  |
|                        |  |                   | 930<br>1190                                    | $T_j=T_{j\ max}$<br>$T_j=25^\circ C$<br>180° half-sine wave;<br>$t_p=8.3\ ms$ ; single pulse;<br>$V_D=V_R=0\ V$ ;<br>Gate pulse: $I_G=2\ A$ ;<br>$t_{GP}=50\ \mu s$ ; $di_G/dt \geq 1\ A/\mu s$ |
| <b>BLOCKING</b>        |  |                   |  |   |
| $V_{DRM}, V_{RRM}$     | Repetitive peak off-state and Repetitive peak reverse voltages         | V                 | 3800 ÷ 4400                                    | $T_{j\ min} < T_j < T_{j\ max}$ ;<br>180° half-sine wave; 50 Hz;<br>Gate open   |
| $V_{DSM}, V_{RSM}$     | Non-repetitive peak off-state and Non-repetitive peak reverse voltages | V                 | 3900 ÷ 4500                                    | $T_{j\ min} < T_j < T_{j\ max}$ ;<br>180° half-sine wave; single pulse; Gate open   |
| $V_D, V_R$             | Direct off-state and Direct reverse voltages                           | V                 | 0.6 $\cdot$ $V_{DRM}$<br>0.6 $\cdot$ $V_{RRM}$ | $T_j=T_{j\ max}$ ;<br>Gate open   |

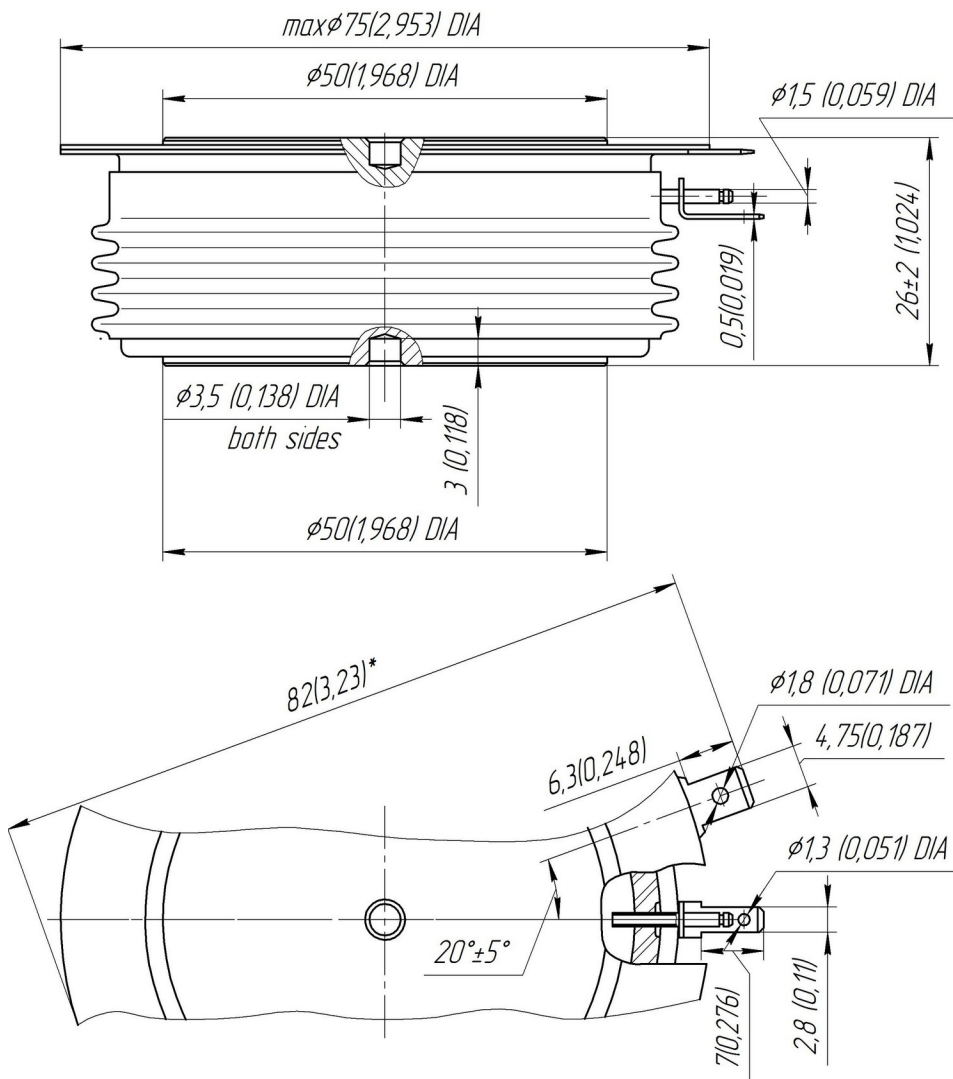
| <b>TRIGGERING</b>  |  |                  |           |  |
|--------------------|--|------------------|-----------|--|
| $I_{FGM}$          | Peak forward gate current  | A                | 8         | $T_j = T_{j\ max}$   |
| $V_{RGM}$          | Peak reverse gate voltage  | V                | 5         |  |
| $P_G$              | Gate power dissipation   | W                | 4         | $T_j = T_{j\ max}$ for DC gate current   |
| <b>SWITCHING</b>   |  |                  |           |  |
| $(di_T/dt)_{crit}$ | Critical rate of rise of on-state current non-repetitive ( $f=1\ Hz$ ) | A/ $\mu s$       | 1000      | $T_j = T_{j\ max}$ ; $V_D = 0.67 \cdot V_{DRM}$ ; $I_{TM} = 2400\ A$ ;<br>Gate pulse: $I_G = 2\ A$ ;<br>$t_{GP} = 50\ \mu s$ ; $di_G/dt \geq 2\ A/\mu s$ |
| <b>THERMAL</b>     |  |                  |           |  |
| $T_{stg}$          | Storage temperature  | $^{\circ}C$      | -60÷50    |  |
| $T_j$              | Operating junction temperature   | $^{\circ}C$      | -60÷125   |  |
| <b>MECHANICAL</b>  |  |                  |           |  |
| F                  | Mounting force   | kN               | 24.0÷28.0 |  |
| a                  | Acceleration   | m/s <sup>2</sup> | 50        | Device clamped   |

## CHARACTERISTICS

| Symbols and parameters |   | Units      | Values                                | Conditions  |   |
|------------------------|---|------------|---------------------------------------|---|---|
| <b>ON-STATE</b>        |   |            |                                       |   |   |
| $V_{TM}$               | Peak on-state voltage, max  | V          | 2.20                                  | $T_j = 25\ ^{\circ}C$ ; $I_{TM} = 1570\ A$  |   |
| $V_{T(TO)}$            | On-state threshold voltage, max                                     | V          | 1.169                                 | $T_j = T_{j\ max}$ ;  |   |
| $r_T$                  | On-state slope resistance, max                                      | m $\Omega$ | 0.757                                 | $0.5\ \pi\ I_{TAV} < I_T < 1.5\ \pi\ I_{TAV}$   |   |
| $I_L$                  | Latching current, max   | mA         | 1500                                  | $T_j = 25\ ^{\circ}C$ ; $V_D = 12\ V$ ;<br>Gate pulse: $I_G = 2\ A$ ;<br>$t_{GP} = 50\ \mu s$ ; $di_G/dt \geq 1\ A/\mu s$                     |   |
| $I_H$                  | Holding current, max  | mA         | 300                                   | $T_j = 25\ ^{\circ}C$ ;<br>$V_D = 12\ V$ ; Gate open  |   |
| <b>BLOCKING</b>        |   |            |                                       |   |   |
| $I_{DRM}, I_{RRM}$     | Repetitive peak off-state and Repetitive peak reverse currents, max | mA         | 150                                   | $T_j = T_{j\ max}$ ;<br>$V_D = V_{DRM}$ ; $V_R = V_{RRM}$   |   |
| $(dv_D/dt)_{crit}$     | Critical rate of rise of off-state voltage <sup>1)</sup> , min      | V/ $\mu s$ | 200, 320, 500, 1000, 1600, 2000, 2500 | $T_j = T_{j\ max}$ ;<br>$V_D = 0.67 \cdot V_{DRM}$ ; Gate open  |   |
| <b>TRIGGERING</b>      |   |            |                                       |   |   |
| $V_{GT}$               | Gate trigger direct voltage, max                                    | V          | 3.00<br>2.50<br>1.50                  | $T_j = T_{j\ min}$<br>$T_j = 25\ ^{\circ}C$<br>$T_j = T_{j\ max}$   | $V_D = 12\ V$ ; $I_D = 3\ A$ ;<br>Direct gate current |
| $I_{GT}$               | Gate trigger direct current, max                                    | mA         | 400<br>250<br>150                     | $T_j = T_{j\ min}$<br>$T_j = 25\ ^{\circ}C$<br>$T_j = T_{j\ max}$   |   |
| $V_{GD}$               | Gate non-trigger direct voltage, min                                | V          | 0.35                                  | $T_j = T_{j\ max}$ ;  |   |
| $I_{GD}$               | Gate non-trigger direct current, min                                | mA         | 40.00                                 | $V_D = 0.67 \cdot V_{DRM}$ ;<br>Direct gate current   |   |
| <b>SWITCHING</b>       |   |            |                                       |   |   |
| $t_{gd}$               | Delay time  | $\mu s$    | 2.75                                  | $T_j = 25\ ^{\circ}C$ ; $V_D = 1500\ V$ ; $I_{TM} = I_{TAV}$ ;<br>$di/dt = 200\ A/\mu s$ ;  |   |
| $t_{gt}$               | Turn-on time, max   | $\mu s$    | 16.00                                 | Gate pulse: $I_G = 2\ A$ ; $V_G = 20\ V$ ;<br>$t_{GP} = 50\ \mu s$ ; $di_G/dt = 2\ A/\mu s$   |   |
| $t_q$                  | Turn-off time <sup>2)</sup> , max                                   | $\mu s$    | 500, 630, 800                         | $dv_D/dt = 50\ V/\mu s$ ; $T_j = T_{j\ max}$ ; $I_{TM} = I_{TAV}$ ;<br>$di_R/dt = -5\ A/\mu s$ ; $V_R = 100V$ ;<br>$V_D = 0.67 \cdot V_{DRM}$ |   |
| $Q_{rr}$               | Total recovered charge, max   | $\mu C$    | 3300                                  | $T_j = T_{j\ max}$ ; $I_{TM} = 800\ A$ ;  |   |
| $t_{rr}$               | Reverse recovery time, max  | $\mu s$    | 55                                    | $di_R/dt = -5\ A/\mu s$ ;   |   |
| $I_{rrM}$              | Peak reverse recovery current, max                                  | A          | 120                                   | $V_R = 100\ V$ ;  |   |

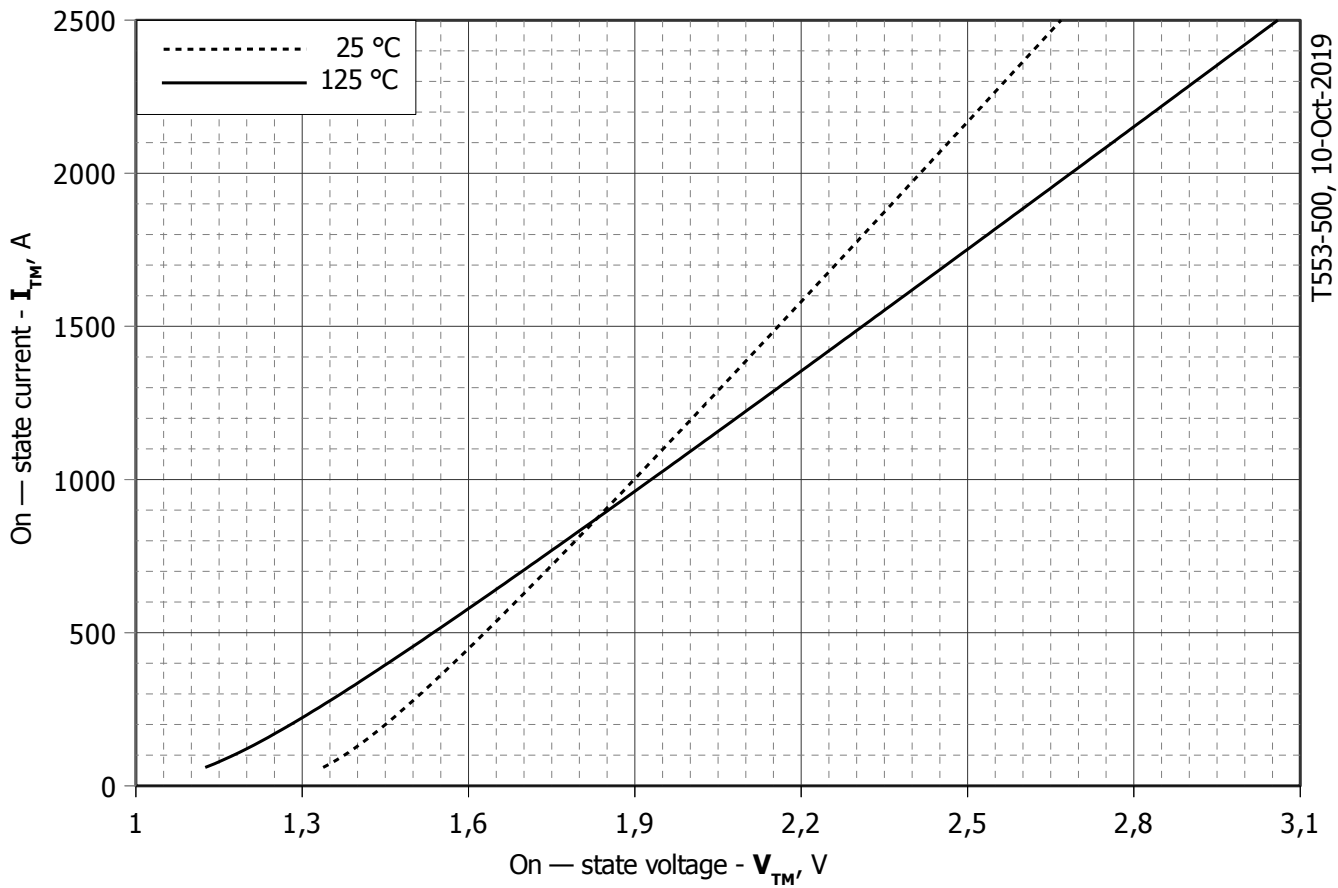
| THERMAL      |   |              |                  |                |                     |
|--------------|---|--------------|------------------|----------------|---------------------|
| $R_{thjc}$   | Thermal resistance, junction to case, max | °C/W         | 0.0180           | Direct current | Double side cooled  |
| $R_{thjc-A}$ |   |              | 0.0396           |                | Anode side cooled   |
| $R_{thjc-K}$ |   |              | 0.0324           |                | Cathode side cooled |
| $R_{thck}$   | Thermal resistance, case to heatsink, max | °C/W         | 0.0040           | Direct current |                     |
| MECHANICAL   |   |              |                  |                |                     |
| w            | Weight, max                               | g            | 510              |                |                     |
| $D_s$        | Surface creepage distance                 | mm<br>(inch) | 31.60<br>(1.244) |                |                     |
| $D_a$        | Air strike distance                       | mm<br>(inch) | 16.50<br>(0.649) |                |                     |

| PART NUMBERING GUIDE   |     |     |    |    |    |   | NOTES  |     |     |     |      |      |      |      |
|--|-----|-----|----|----|----|---|--|-----|-----|-----|------|------|------|------|
| T  | 553 | 500 | 44 | A2 | B2 | N | <sup>1)</sup> Critical rate of rise of off-state voltage |     |     |     |      |      |      |      |
| 1  | 2   | 3   | 4  | 5  | 6  | 7 | Symbol of Group  | P2  | K2  | E2  | A2   | T1   | P1   | M1   |
| 1. Phase Control Thyristor<br>2. Design version<br>3. Mean on-state current, A<br>4. Voltage code<br>5. Critical rate of rise of off-state voltage, V/μs<br>6. Turn-off time ( $dv_D/dt=50$ V/μs)<br>7. Ambient conditions: N – normal; T – tropical |     |     |    |    |    |   | ( $dv_D/dt$ ) <sub>crit</sub> , V/μs                     | 200 | 320 | 500 | 1000 | 1600 | 2000 | 2500 |
|  |     |     |    |    |    |   | <sup>2)</sup> Turn-off time ( $dv_D/dt=50$ V/μs)         |     |     |     |      |      |      |      |
|  |     |     |    |    |    |   | Symbol of Group  | E2  |     | C2  |      | B2   |      |      |
|  |     |     |    |    |    |   | $t_q$ , μs   | 500 |     | 630 |      | 800  |      |      |



All dimensions in millimeters (inches)

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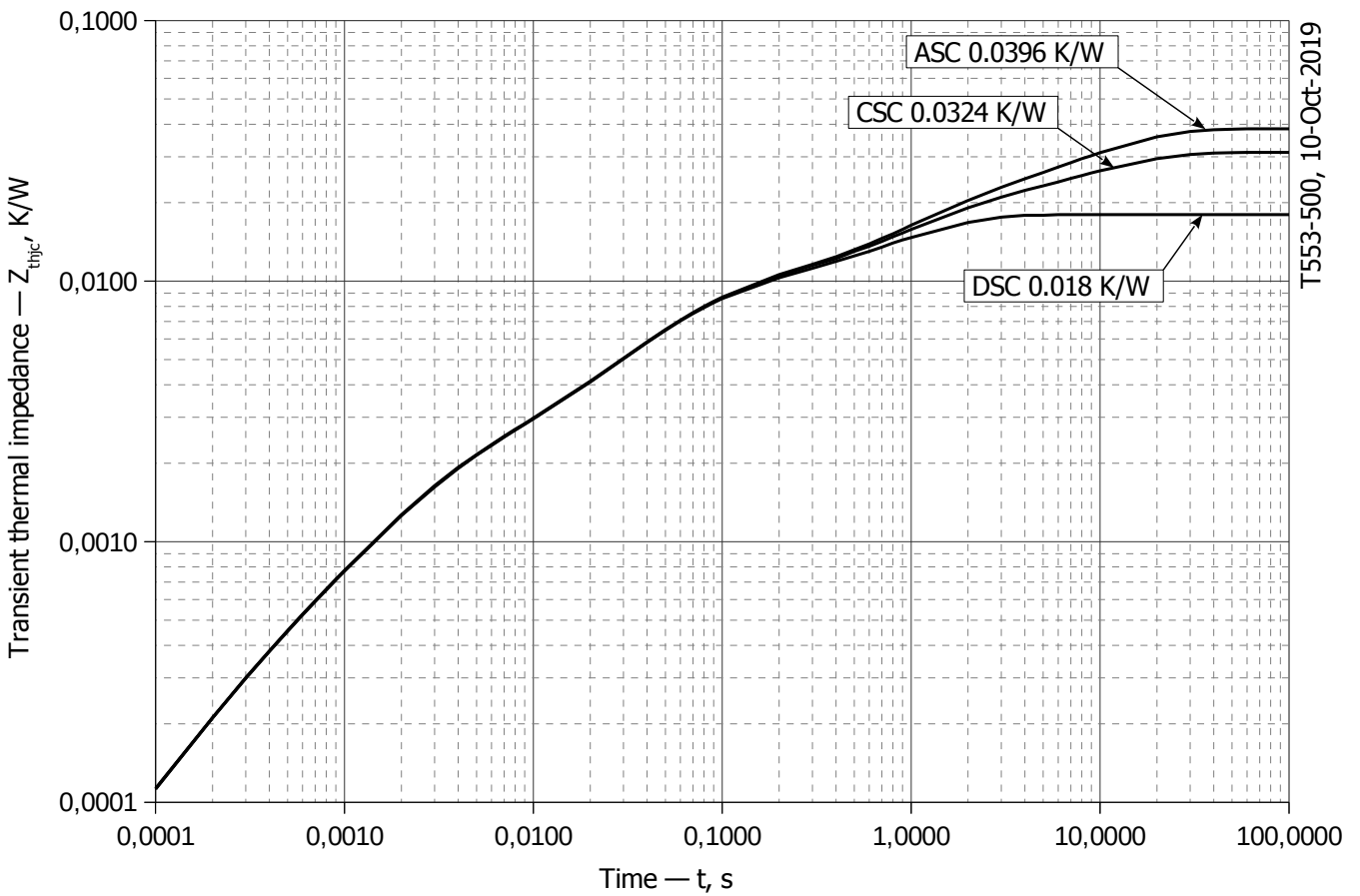
**Fig 1 – On-state characteristics of Limit device**

Analytical function for On-state characteristic:

$$V_T = A + B \cdot i_T + C \cdot \ln(i_T + 1) + D \cdot \sqrt{i_T}$$

|          | Coefficients for max curves |                         |
|----------|-----------------------------|-------------------------|
|          | $T_j = 25^\circ\text{C}$    | $T_j = T_{j\text{max}}$ |
| <b>A</b> | 1.14870000                  | 0.89380000              |
| <b>B</b> | 0.00050006                  | 0.00073270              |
| <b>C</b> | 0.04047300                  | 0.04675300              |
| <b>D</b> | -0.00093708                 | -0.00063193             |

**On-state characteristic model (see Fig. 1)**



T553-500, 10-Oct-2019

**Fig 2 – Transient thermal impedance  $Z_{thjc}$  vs. time  $t$**

Analytical function for Transient thermal impedance junction to case  $Z_{thjc}$  for DC:

$$Z_{thjc} = \sum_{i=1}^n R_i \left( 1 - e^{-\frac{t}{\tau_i}} \right)$$

Where  $i = 1$  to  $n$ ,  $n$  is the number of terms in the series.

$t$  = Duration of heating pulse in seconds.

$Z_{thjc}$  = Thermal resistance at time  $t$ .

$R_i$  = Amplitude of  $p_{th}$  term.

$\tau_i$  = Time constant of  $r_{th}$  term.

DC Double side cooled

| $i$          | 1        | 2        | 3        | 4        | 5         | 6          |
|--------------|----------|----------|----------|----------|-----------|------------|
| $R_i$ , K/W  | 0.009241 | 0.006037 | 0.001231 | 0.001054 | 0.0003396 | 0.00009575 |
| $\tau_i$ , s | 0.9673   | 0.04967  | 0.002733 | 0.07734  | 0.001638  | 0.0002248  |

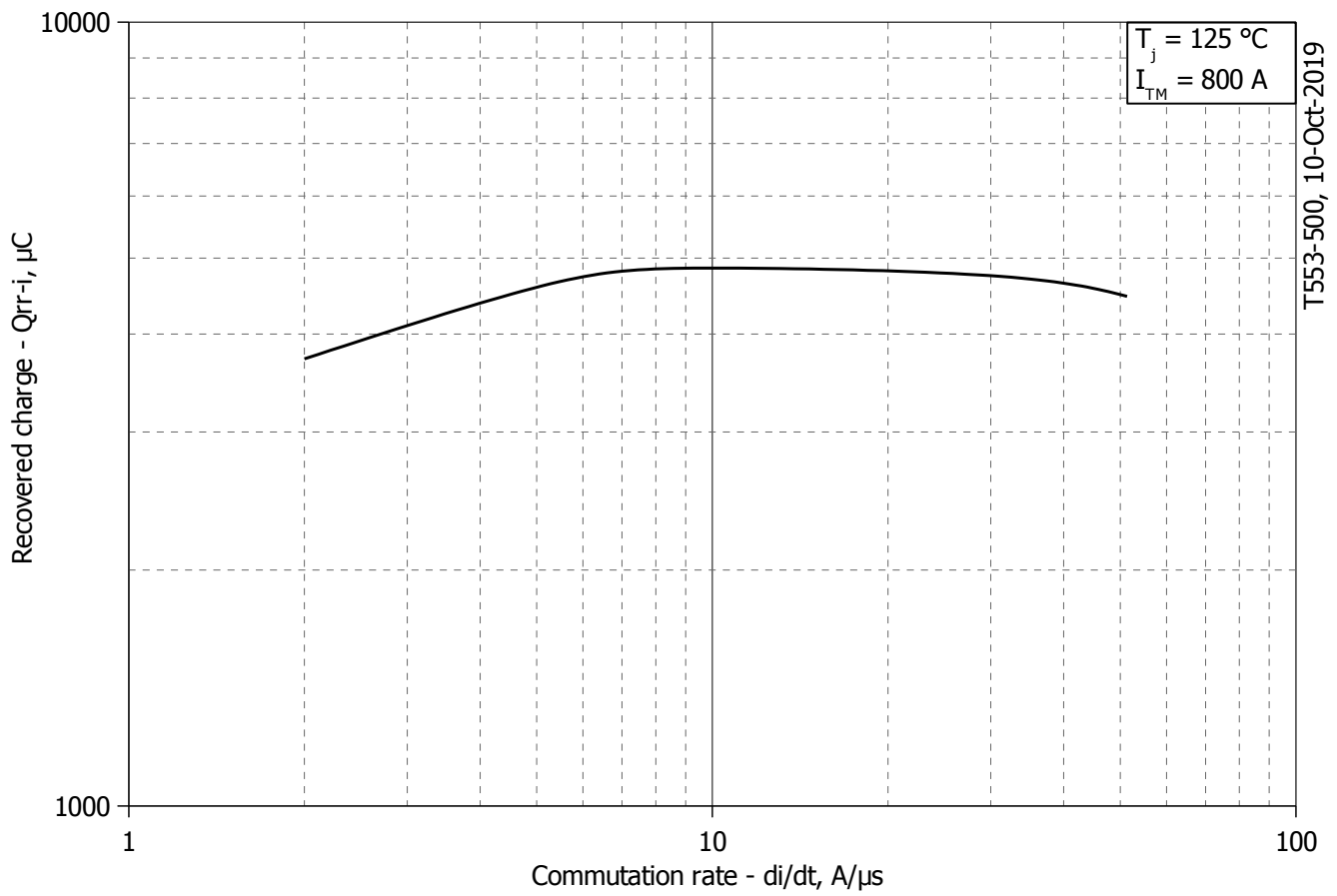
DC Anode side cooled

| $i$          | 1       | 2        | 3        | 4        | 5        | 6         |
|--------------|---------|----------|----------|----------|----------|-----------|
| $R_i$ , K/W  | 0.01318 | 0.009281 | 0.006055 | 0.001018 | 0.001535 | 0.0001182 |
| $\tau_i$ , s | 9.745   | 1.028    | 0.05591  | 0.03732  | 0.002468 | 0.0002687 |

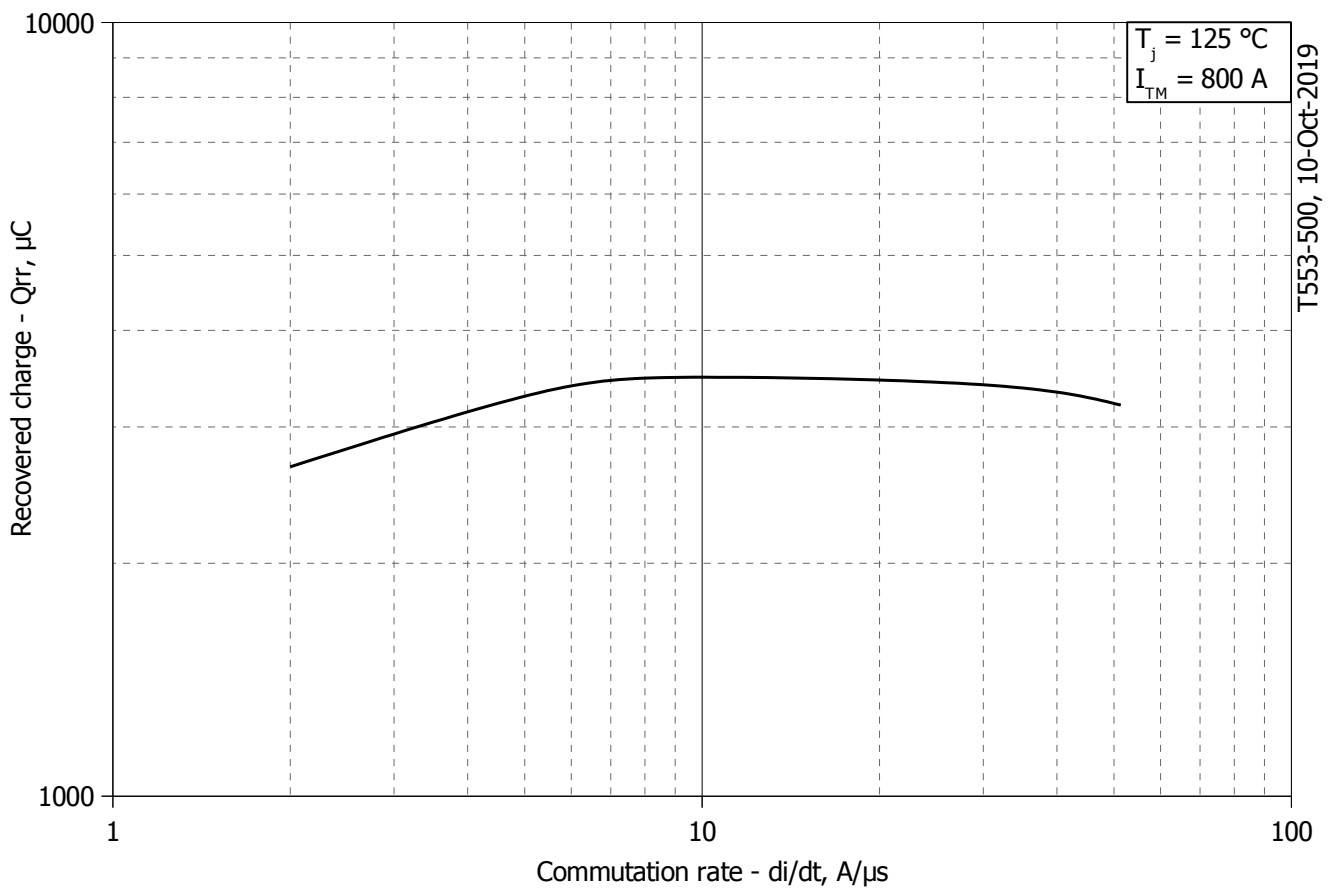
DC Cathode side cooled

| $i$          | 1       | 2        | 3        | 4         | 5        | 6         |
|--------------|---------|----------|----------|-----------|----------|-----------|
| $R_i$ , K/W  | 0.02041 | 0.009325 | 0.006949 | 0.0001252 | 0.001516 | 0.0001119 |
| $\tau_i$ , s | 9.752   | 1.065    | 0.05344  | 0.01407   | 0.002421 | 0.0002554 |

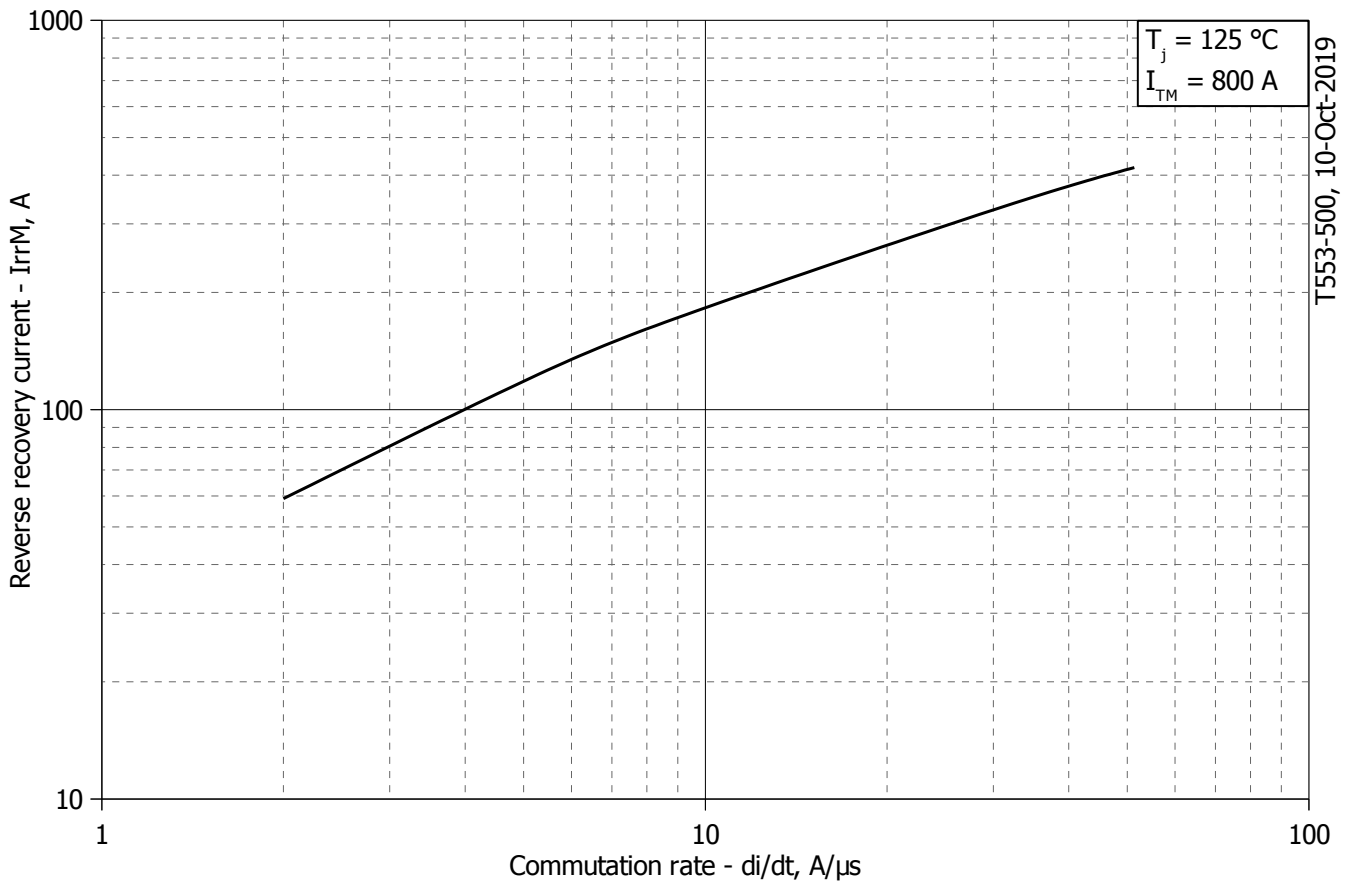
**Transient thermal impedance junction to case  $Z_{thjc}$  model (see Fig. 2)**



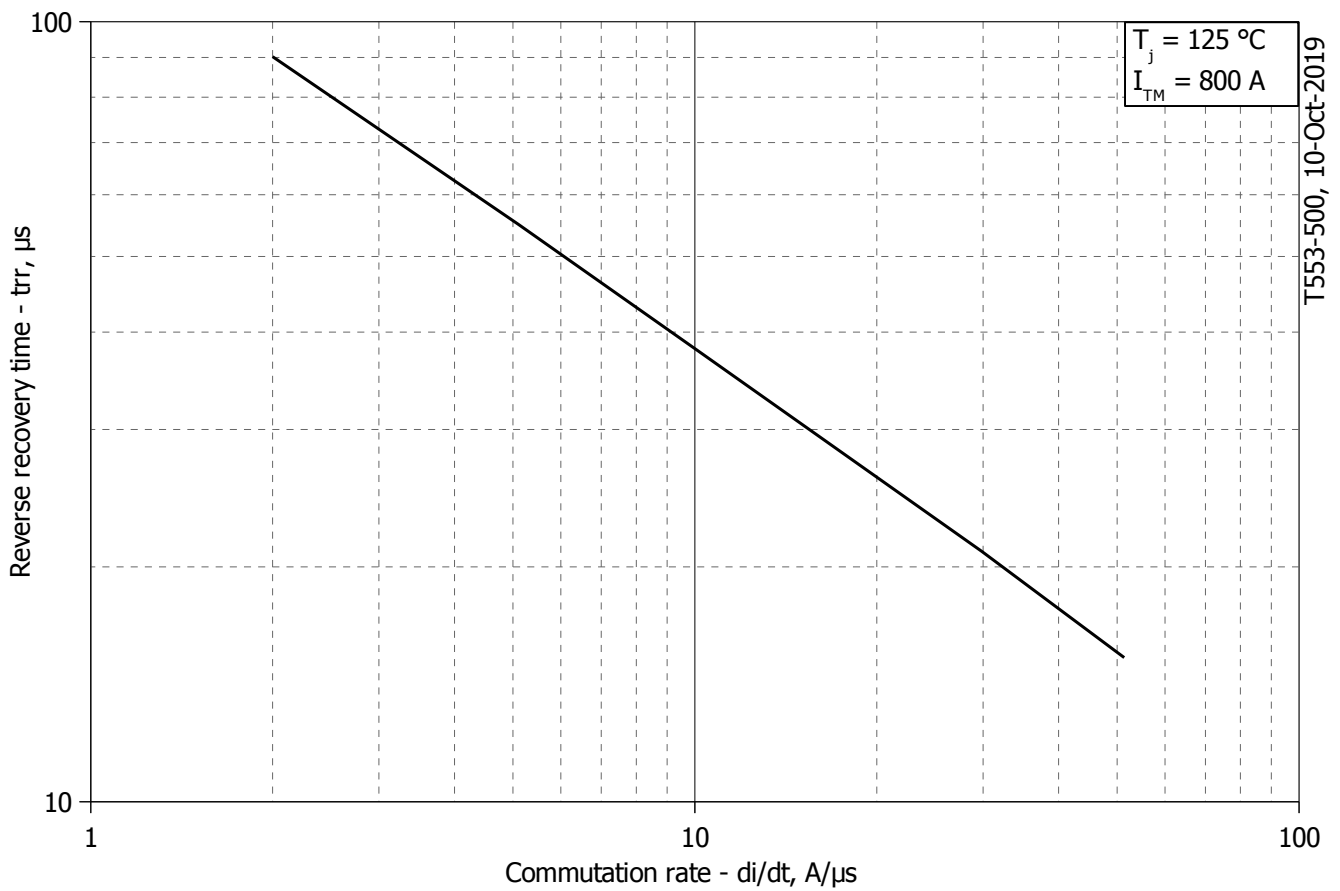
**Fig 3 – Maximum recovered charge  $Q_{rr-i}$  (integral) vs. commutation rate  $di_R/dt$**



**Fig 4 – Maximum recovered charge  $Q_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**

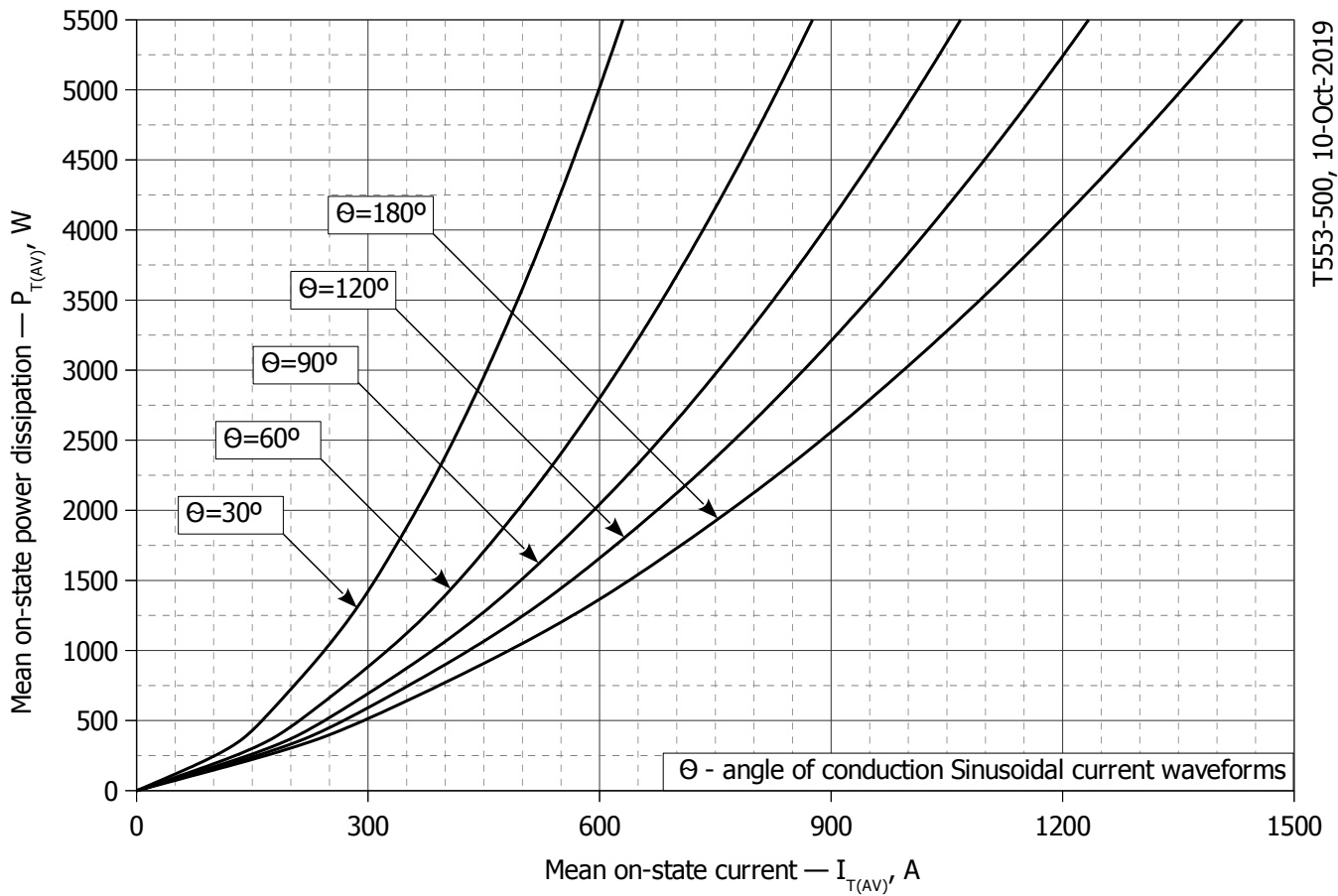


**Fig 5 – Maximum reverse recovery current  $I_{rrM}$  vs. commutation rate  $di_R/dt$**

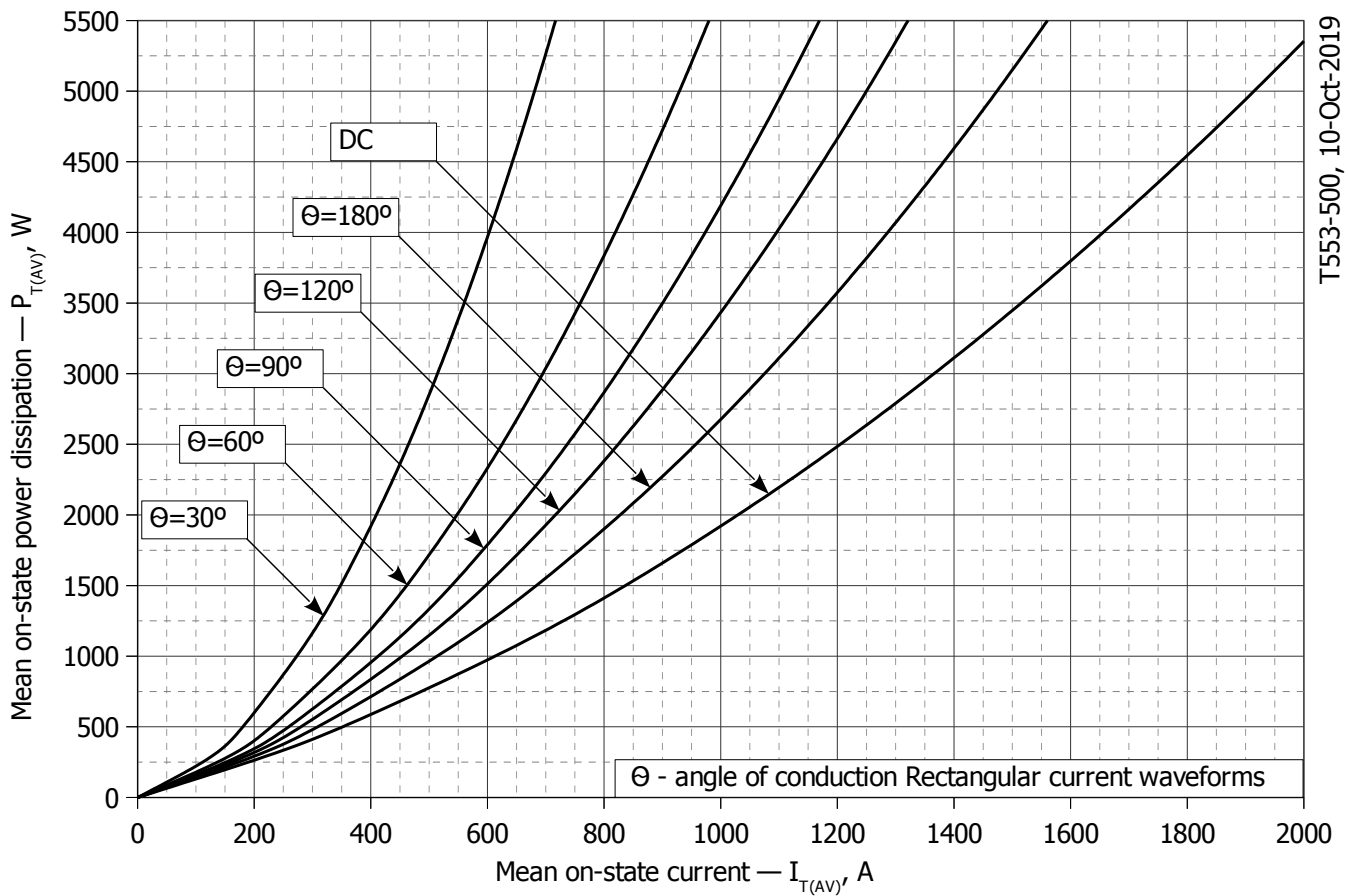


**Fig 6 – Maximum recovery time  $t_{rr}$  vs. commutation rate  $di_R/dt$  (25% chord)**

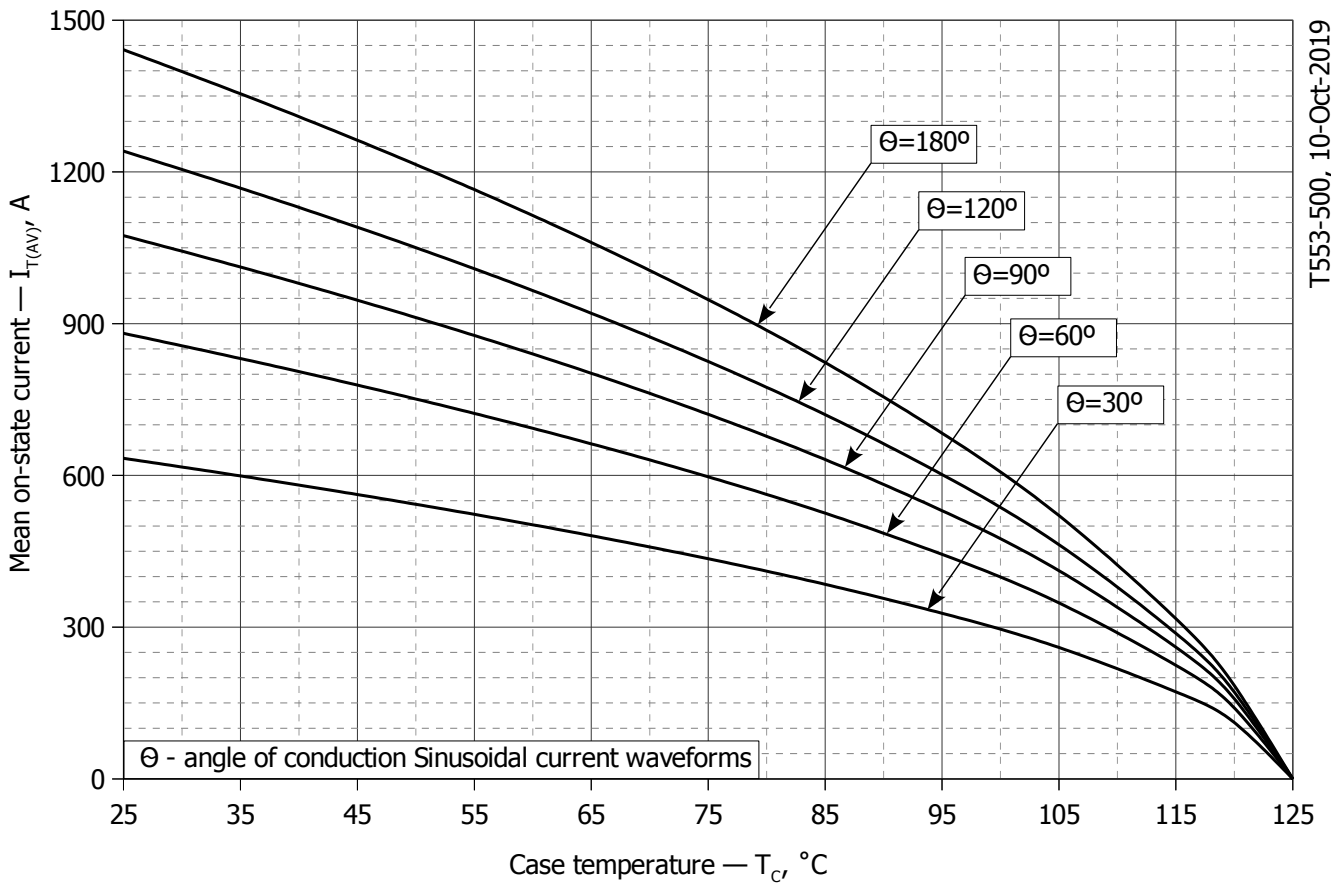




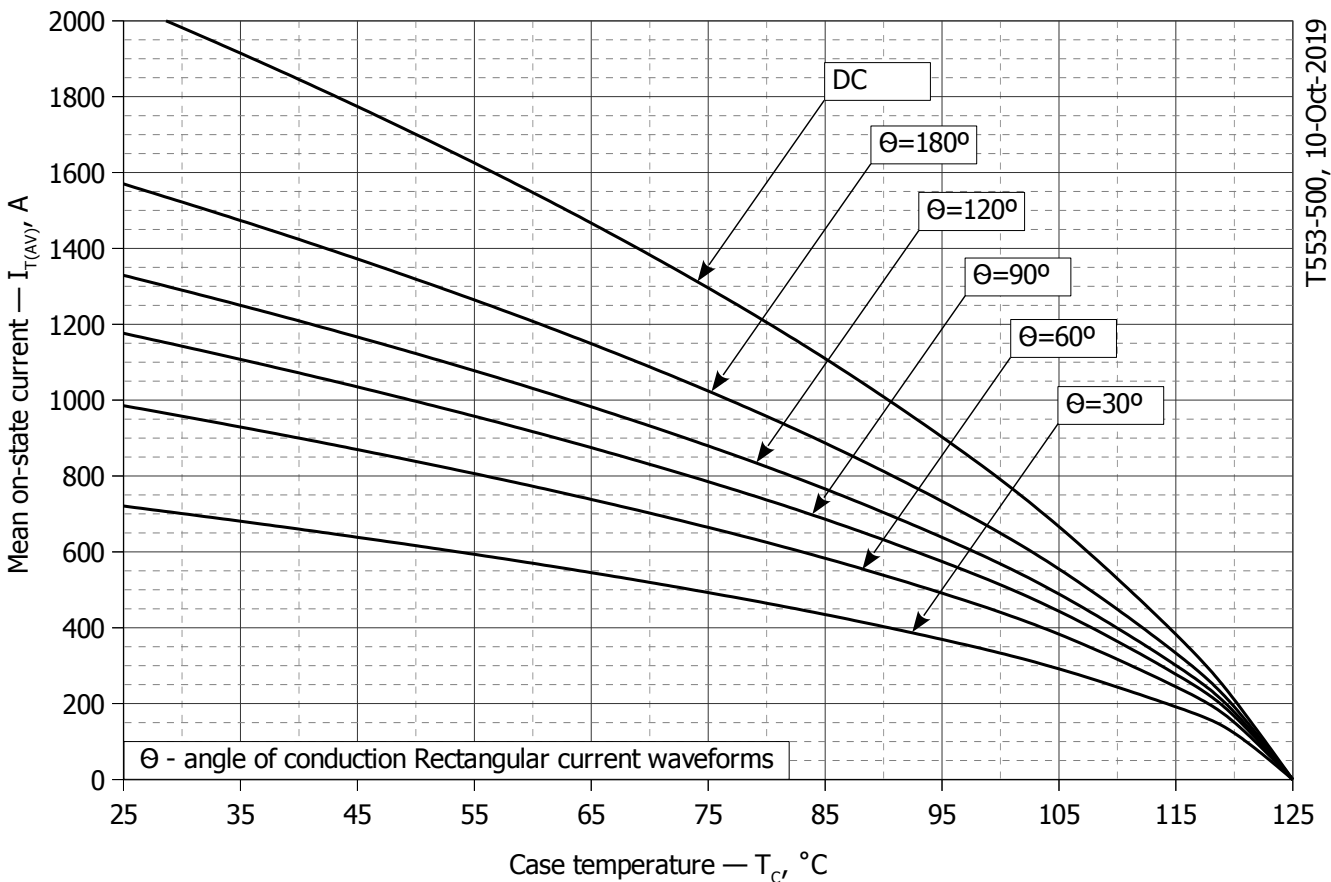
**Fig. 7 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**



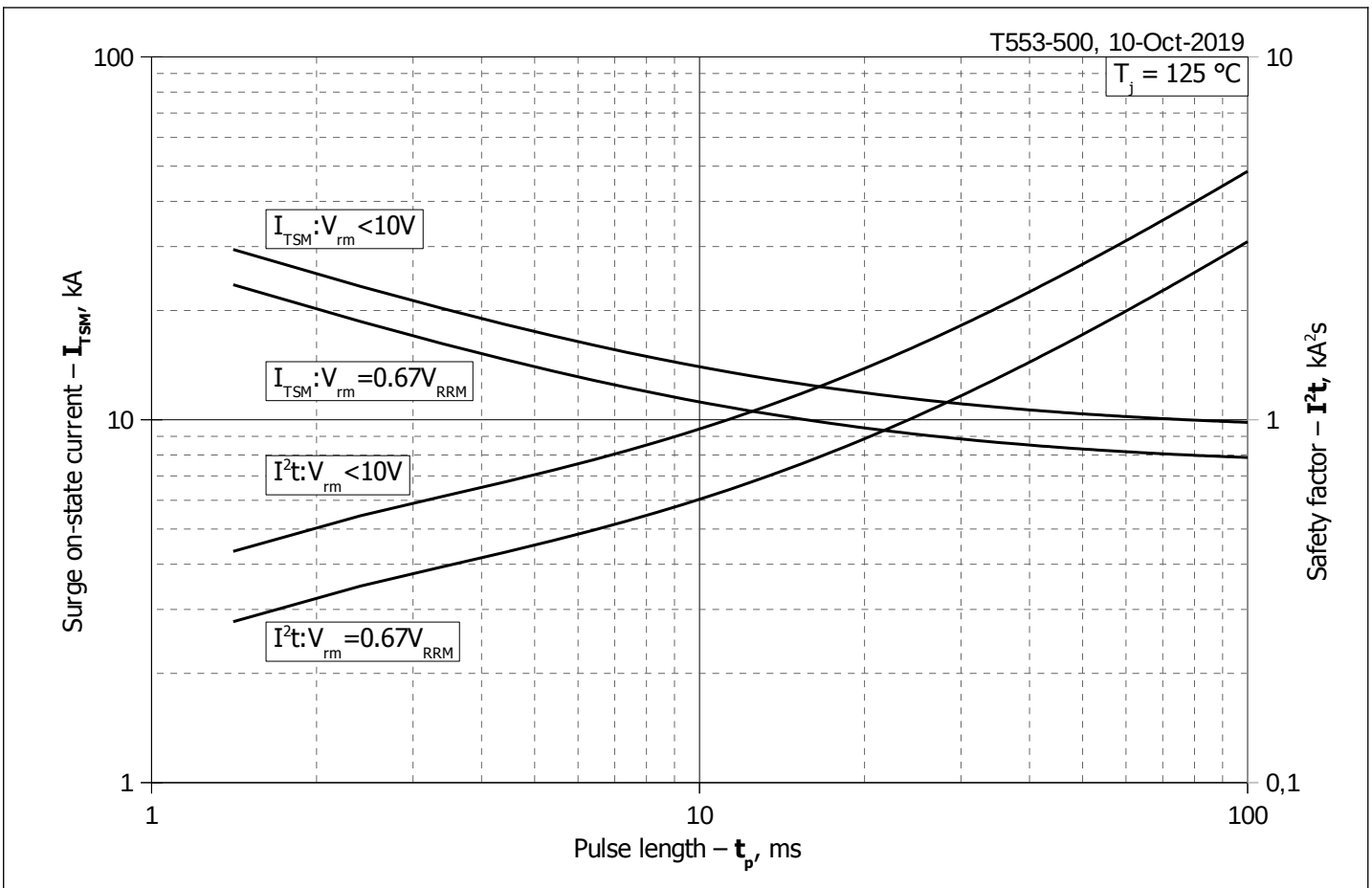
**Fig. 8 - Mean on-state power dissipation  $P_{TAV}$  vs. mean on-state current  $I_{TAV}$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



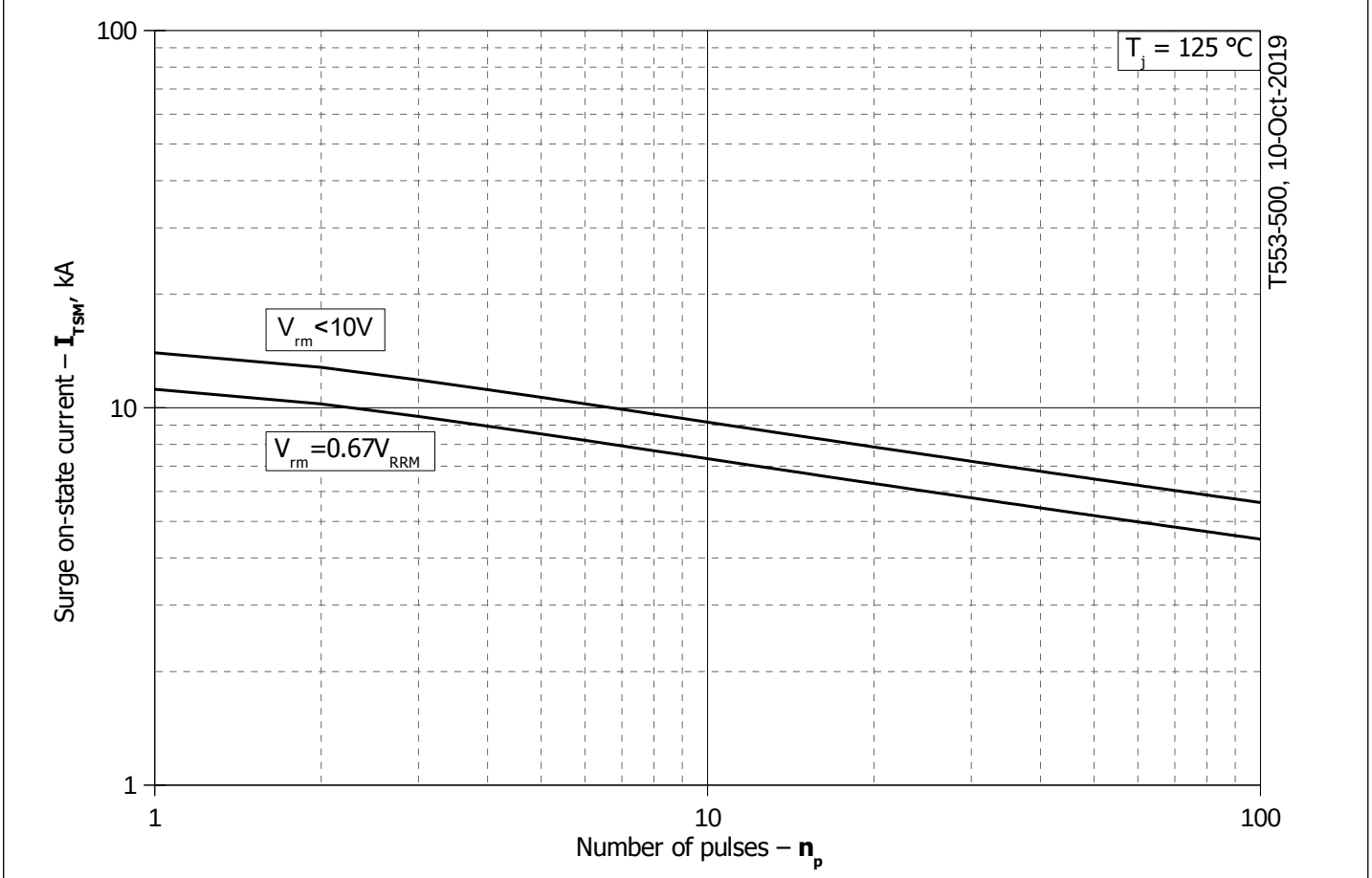
**Fig. 9 – Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for sinusoidal current waveforms at different conduction angles ( $f=50\text{Hz}$ , DSC)**



**Fig. 10 - Mean on-state current  $I_{TAV}$  vs. case temperature  $T_c$  for rectangular current waveforms at different conduction angles and for DC ( $f=50\text{Hz}$ , DSC)**



**Fig. 11 – Maximum surge on-state current  $I_{TSM}$  and safety factor  $I^2t$  vs. pulse length  $t_p$**



**Fig. 12 - Maximum surge on-state current  $I_{TSM}$  vs. number of pulses  $n_p$**